# **Inverter Grade Thyristors** (Stud Version), 330 A



TO-118 (TO- 209AE)

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PRIMARY CHARACTERISTICS					
I <sub>T(AV)</sub>	330 A				
V <sub>DRM</sub> /V <sub>RRM</sub>	400 V, 800 V				
V <sub>TM</sub>	1.96 V				
I <sub>TSM</sub> at 50 Hz	11 000 A				
I <sub>TSM</sub> at 60 Hz	11 520 A				
I <sub>GT</sub>	200 mA				
TJ	-40 °C to +125 °C				
T <sub>C</sub>	75 °C				
Package	TO-118 (TO-209AE)				
Circuit configuration	Single SCR				

## **FEATURES**

- Center amplifying gate
- · High surge current capability
- · Low thermal impedance
- High speed performance
- Compression bonding
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## **TYPICAL APPLICATIONS**

- Inverters
- Choppers
- Induction heating
- · All types of force-commutated converters

MAJOR RATINGS AND CHARACTERISTICS							
PARAMETER	TEST CONDITIONS	VALUES	UNITS				
1		330	A				
I <sub>T(AV)</sub>	T <sub>C</sub>	75	°C				
I <sub>T(RMS)</sub>		518					
1	50 Hz	11 000	A				
ITSM	60 Hz	11 520					
l <sup>2</sup> t	50 Hz	605	kA <sup>2</sup> s				
1-1	60 Hz	550	KA-S				
V <sub>DRM</sub> /V <sub>RRM</sub>		400 to 800	V				
t <sub>q</sub>		15	μs				
TJ		-40 to +125	°C				

#### **ELECTRICAL SPECIFICATIONS**

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VOLTAGE R	ATINGS				
TYPE NUMBER	VOLTAGE CODE	V <sub>DRM</sub> /V <sub>RRM</sub> , MAXIMUM REPETITIVE PEAK VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$I_{DRM}/I_{RRM} MAXIMUM AT T_J = T_J MAXIMUM MA$	
VC CT222C	VS-ST333S 04		500	50	
V3-313333	08	800	900		

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CURRENT CARRYING CAPABILITY								
FREQUENCY	<u>180° e</u>		180° e		100 µ	s	UNITS	
50 Hz	840	600	1280	1040	5430	4350		
400 Hz	650	450	1280	910	2150	1560	A	
1000 Hz	430	230	1090	730	1080	720		
2500 Hz	140	60	490	250	400	190		
Recovery voltage V <sub>R</sub>	5	0	50		50		V	
Voltage before turn-on V <sub>D</sub>	VD	V <sub>DRM</sub>		V <sub>DRM</sub>		RM	v	
Rise of on-state current dl/dt	50		-		-		A/µs	
Case temperature	50	75	50	75	50	75	°C	
Equivalent values for RC circuit	10/0	0.47	10/	0.47	10/0.47		Ω/μF	

<b>ON-STATE CONDUCTION</b>						
PARAMETER	SYMBOL		VALUES	UNITS		
Maximum average on-state	L	190° condu	ction, half sine v	NOVO	330	А
current at case temperature	I <sub>T(AV)</sub>		ction, nan sine v	wave	75	°C
Maximum RMS on-state current	I <sub>T(RMS)</sub>	DC at 63 °C	case temperat	ure	518	
		t = 10 ms	No voltage		11 000	
Maximum peak, one half cycle,		t = 8.3 ms	reapplied		11 520	А
non-repetitive surge current	I <sub>TSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>		9250	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	9700	
		t = 10 ms	No voltage	initial $T_J = T_J$ maximum	605	- kA <sup>2</sup> s
Maximum I <sup>2</sup> t for fusing	l <sup>2</sup> t	t = 8.3 ms	reapplied		550	
		t = 10 ms	100 % V <sub>RRM</sub>		430	
		t = 8.3 ms	reapplied		390	
Maximum I²√t for fusing	l²√t	t = 0.1 ms t	o 10 ms, no volt	age reapplied	6050	kA²√s
Maximum peak on-state voltage	V <sub>TM</sub>		A, $T_J = T_J$ maxin sine wave pulse		1.96	
Low level value of threshold voltage	V <sub>T(TO)1</sub>	(16.7 % x π	$x I_{T(AV)} < I < \pi x$	$I_{T(AV)}$ ), $T_J = T_J$ maximum	0.91	V
High level value of threshold voltage	V <sub>T(TO)2</sub>	$(I > \pi \times I_{T(AV)})$	0.92			
Low level value of forward slope resistance	r <sub>t1</sub>	(16.7 % x $\pi$ x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$ ), $T_J = T_J$ maximum		0.58		
High level value of forward slope resistance	r <sub>t2</sub>	$(I > \pi \times I_{T(AV)}), T_J = T_J maximum$		0.58	mΩ	
Maximum holding current	Ι <sub>Η</sub>	T <sub>J</sub> = 25 °C,	I <sub>T</sub> > 30 A		600	m۸
Typical latching current	١L	T <sub>J</sub> = 25 °C,	V <sub>A</sub> = 12 V, R <sub>a</sub> =	6 Ω, I <sub>G</sub> = 1 A	1000	mA

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	$T_J = T_J$ maximum, $V_{DRM} = Rated V_{DRM}$ $I_{TM} = 2 x dl/dt$	1000	A/µs
Typical delay time	t <sub>d</sub>	$T_J$ = 25 °C, $V_{DM}$ = Rated $V_{DRM}$ , $I_{TM}$ = 50 A DC, $t_p$ = 1 µs Resistive load, gate pulse: 10 V, 5 $\Omega$ source	1.0	
Maximum turn-off time	tq	$T_J = T_J$ maximum, $I_{TM} = 550$ A, commutating dl/dt = 40 A/µs $V_R = 50$ V, $t_p = 500$ µs, dV/dt = 200 V/µs	15	μs

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BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum, linear to 80 % V <sub>DRM</sub> , higher value available on request	500	V/µs
Maximum peak reverse and off-state leakage current	I <sub>RRM</sub> , I <sub>DRM</sub>	$T_J = T_J$ maximum, rated $V_{DRM}/V_{RRM}$ applied	50	mA

TRIGGERING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum peak gate power	P <sub>GM</sub>	T <sub>.1</sub> = T <sub>.1</sub> maximum, f = 50 Hz, d% = 50	60	w
Maximum average gate power	P <sub>G(AV)</sub>	1j = 1j maximum, 1 = 30 m2, 0.70 = 50	10	٧V
Maximum peak positive gate current	I <sub>GM</sub>		10	А
Maximum peak positive gate voltage	$+V_{GM}$	$T_J = T_J$ maximum, $t_p \le 5$ ms	20	V
Maximum peak negative gate voltage	-V <sub>GM</sub>		5	
Maximum DC gate current required to trigger	I <sub>GT</sub>	$T = 25^{\circ}C V = 12 V R = 6 O$	200	mA
Maximum DC gate voltage required to trigger	V <sub>GT</sub>	$T_J = 25 \text{ °C}, V_A = 12 \text{ V}, R_a = 6 \Omega$	3	V
Maximum DC gate current not to trigger	I <sub>GD</sub>	$T_J = T_J$ maximum, rated $V_{DRM}$ applied	20	mA
Maximum DC gate voltage not to trigger	V <sub>GD</sub>	IJ = IJ maximum, rated V <sub>DRM</sub> applied	0.25	V

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum operating junction temperature range	TJ		-40 to +125	0°			
Maximum storage temperature range	T <sub>Stg</sub>		-40 to +150	U			
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	0.10	K/W			
Maximum thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, smooth, flat and greased	0.03	rv/ vv			
Mounting torque, ± 10 %		Non-lubricated threads	48.5 (425)	N · m (lbf · in)			
Approximate weight			535	g			
Case style		See dimensions - link at the end of datasheet	TO-118 (TO-209AE)				

CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS					
180°	0.011	0.008							
120°	0.013	0.014							
90°	0.017	0.018	$T_J = T_J maximum$	K/W					
60°	0.025	0.026							
30°	0.041	0.042							

Note

• The table above shows the increment of thermal resistance RthJ-hs when devices operate at different conduction angles than DC



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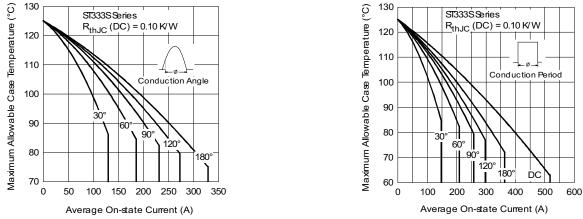


Fig. 1 - Current Ratings Characteristics



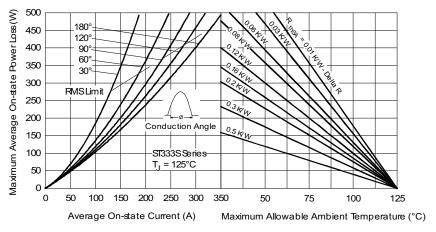


Fig. 3 - On-State Power Loss Characteristics

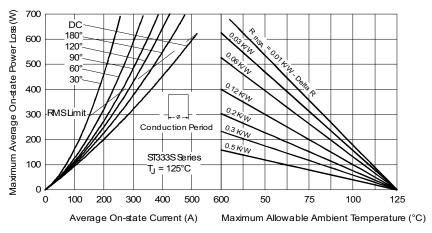


Fig. 4 - On-State Power Loss Characteristics



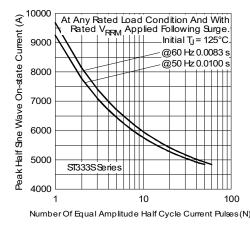


Fig. 5 - Maximum Non-Repetitive Surge Current

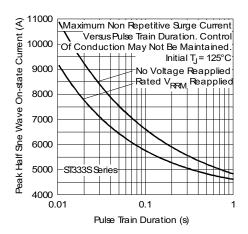


Fig. 6 - Maximum Non-Repetitive Surge Current

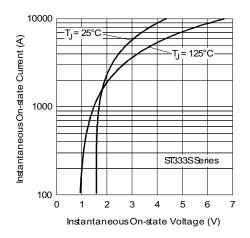


Fig. 7 - On-State Voltage Drop Characteristics

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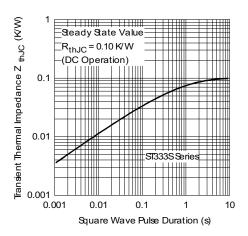


Fig. 8 - Thermal Impedance ZthJC Characteristics

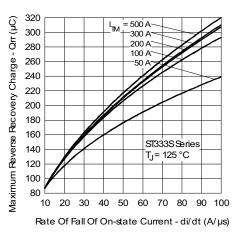


Fig. 9 - Reverse Recovered Charge Characteristics

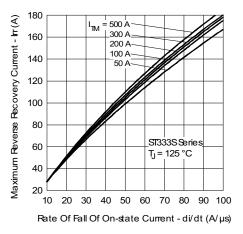


Fig. 10 - Reverse Recovery Current Characteristics

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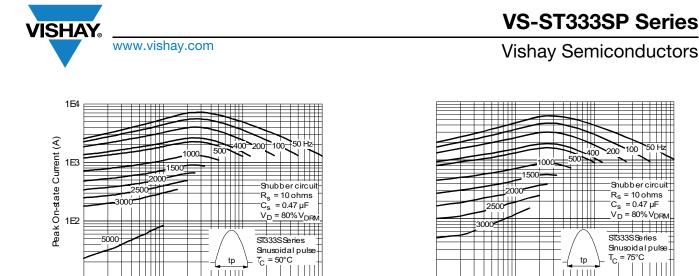


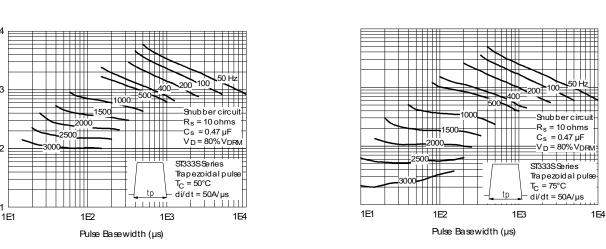
Fig. 11 - Frequency Characteristics

1E4

1E3

1E2

Pulse Basewidth (µs)



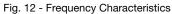
1E1

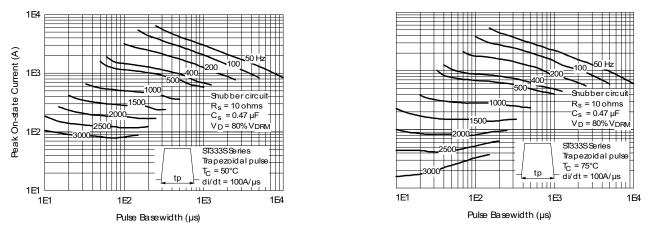
1E2

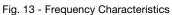
Pulse Basewidth (µs)

1E3

1E4







1E1

1E4

1E3

1E2

1E1

Peak On-state Current (A)

1E1

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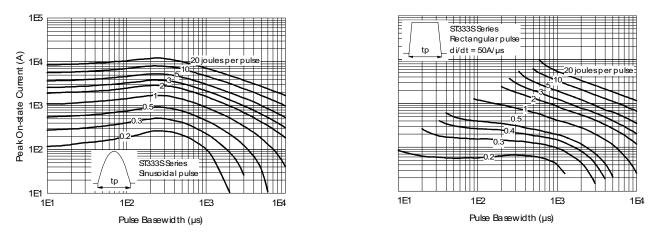


Fig. 14 - Maximum On-State Energy Power Loss Characteristics

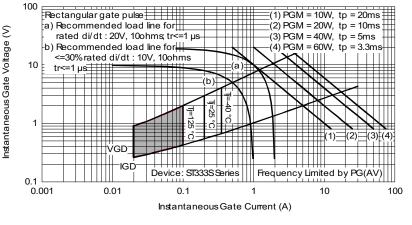


Fig. 15 - Gate Characteristics

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## **ORDERING INFORMATION TABLE**

Device code	VS-	ST	33	3	S	08	Р	F	L	0	Р
	1	2	3	4	5	6	7	8	9	(10)	(11)
	<ol> <li>Vishay Semiconductors product</li> <li>Thyristor</li> <li>Essential part number</li> <li>3 = fast turn-off</li> <li>S = compression bonding stud</li> <li>Voltage code x 100 = V<sub>RRM</sub> (see Voltage Ratings table)</li> </ol>										
	7 - 8 - 9 - 10 -	Rea t <sub>q</sub> c 0 =	P = stud base 3/4" 16UNF-2A / M = metric device Reapplied dV/dt code (for $t_q$ test condition) F = 200 V/µs $t_q$ code (L = 15 µs) M = 12 µs 0 = eyelet terminals (gate and auxiliary cathode leads)								
	<b>11</b> - -	1 = (gat Nor	(gate and auxiliary cathode leads) 1 = fast-on terminals (gate and auxiliary cathode leads) None = standard production P = lead (Pb)-free								

Note: For metric device M24 x 1.5 contact factory

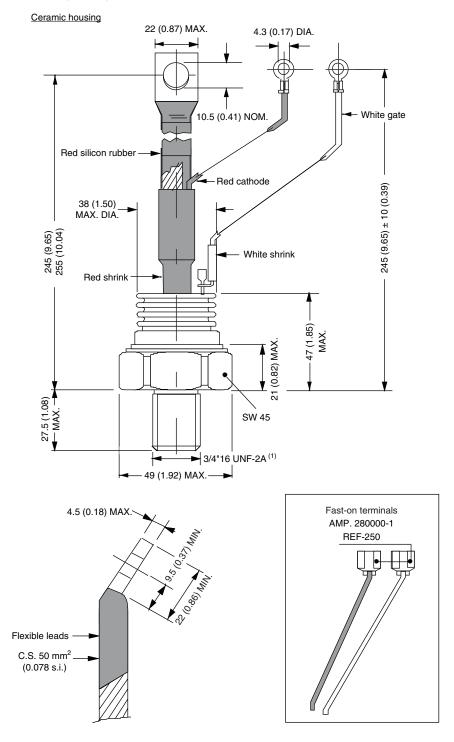
LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95080				
Dimensions	www.visnay.com/doc?95080				

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# TO-209AE (TO-118)

### **DIMENSIONS** in millimeters (inches)



#### Note

<sup>(1)</sup> For metric device: M24 x 1.5 - length 21 (0.83) maximum

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